# XD6121/XD6122 XD6123/XD6124 Series

TOIREX

ETR02040-004

☆AEC-Q100 Grade3

Voltage Detector with Watchdog Function and ON/OFF Control

### ■GENERAL DESCRIPTION

The XD6121/XD6122/XD6123/XD6124 series is a group of high-precision, low current consumption voltage detectors with watchdog functions incorporating CMOS process technology. The series consist of a reference voltage source, delay circuit, comparator, and output driver. With the built-in delay circuit, the series do not require any external components to output signals with release delay time. The output type is VDFL low when detected. The EN/ENB pin can control ON and OFF of the watchdog functions. By setting the EN/ENB pin to low or high level, the watchdog function can be OFF while the voltage detector remains operation. Since the EN/ENB pin of the XD6122 and XD6124 series is internally pulled up to the VIN pin or pulled down to the Vss pin, these series can be used with the EN/ENB pin left open when the watchdog functions is used. The detect voltages are 1.6V, 2.2V, 2.3V, 2.4V, 2.9V, 3.0V, 3.1V, 4.4V, 4.5V, 4.6V, using laser trimming technology. Six watchdog timeout periods are available in a range from 50ms to 1.6s. Five release delay times are available in a range from 3.13ms to 400ms.

### ■ APPLICATIONS

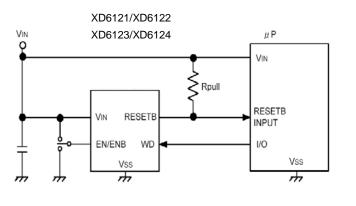
- Microprocessor watchdog monitoring and reset circuits
- Memory battery backup circuits
- System power-on reset circuits
- Power failure detection

### **FEATURES**

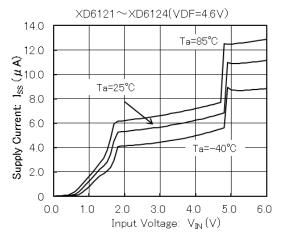
Detect Voltage Range : 1.6V, 2.	
(Standard) 3.0V, 3.7	IV, 4.4V, 4.5V, 4.6V
Hysteresis Width : VDFL x 5	5% (TYP.)
<b>Operating</b> Voltage: 1.0V ~ 6	5.0V
Range	
Detect Voltage: +100pp	m/ºC(TYP)
Temperature	
Characteristics	
Output Configuration : N-chann	ol opon drain
Watchdog Pin : Watchd	
If watch	dog input maintains 'H' or 'L' within
	chdog timeout period, a reset
	output from the RESETB pin.
EN/ENB Pin : When the	ne EN/ENB pin voltage is set to
low or	high level, the watchdog function
is force	
Release Delay Time : 400ms,	200ms, 100ms, 50ms, 3.13ms
(TYP.)	
· · · · · ·	0ms, 400ms, 200ms, 100ms,
Period 50ms (T	
	,
Operating Ambient: -40°C~ -	
Temperature : SOT-25	
Package : EU RoH	IS Compliant, Pb Free
Environmentally	
Friendly	
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# ■ TYPICAL APPLICATION CIRCUIT

### ■ TYPICAL PERFORMANCE CHARACTERISTICS



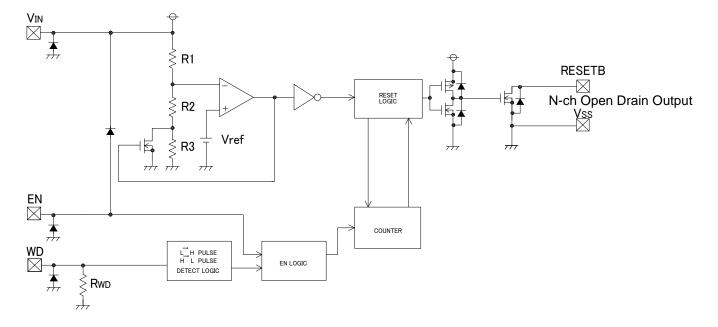
#### Supply Current vs. Input Voltage



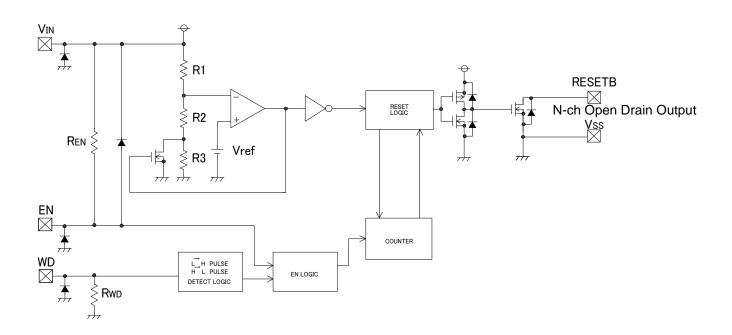
# XD6121/XD6122/XD6123/XD6124 Series

# ■ BLOCK DIAGRAMS

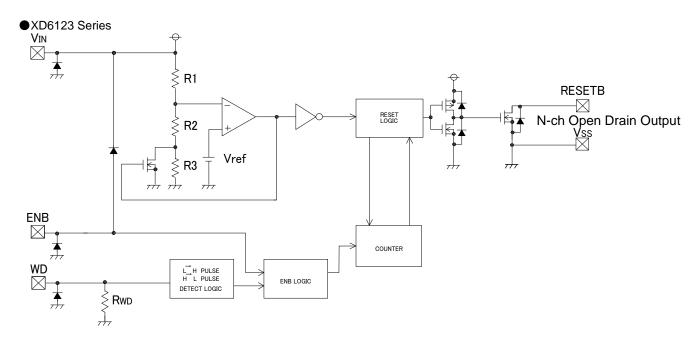
●XD6121 Series



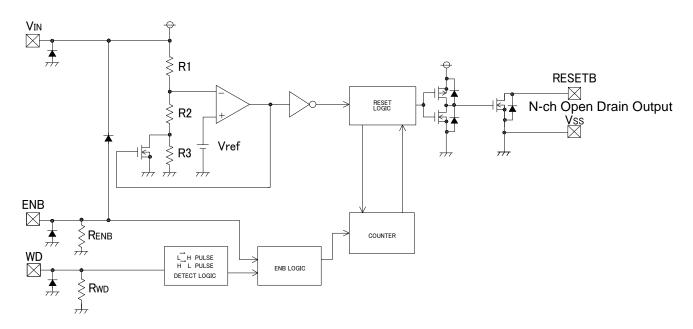
●XD6122 Series



# ■ BLOCK DIAGRAMS (Continued)



#### XD6124 Series



# ■ PRODUCT CLASSIFICATION

#### Selection Guide

	RESET OL	JTPUT		EN/ENB PIN FUNCTION		
SERIES	Vdfl (RESETB) (*1)	Vdfh (RESET)	HYSTERESIS	EN/ENB Input Logic (*2)	Pull-Up or Down Resistor	
XD6121	N-channel open drain	-	Available: V <sub>DFL</sub> x 5% (TYP.)	EN	With No Pull-Up Resistor	
XD6122	N-channel open drain	-		Available:	EN	With Pull-Up Resistor
XD6123	N-channel open drain	-		ENB	With No Pull-Down Resistor	
XD6124	N-channel open drain	-		ENB	With Pull-Down Resistor	

 $^{(\mbox{\tiny $^{1}}}}}})}}} } } } } } } } } } iset to L level at the time of detection. }$ 

 $^{\scriptscriptstyle(2)}$  EN input logic: The watchdog function turns on when the EN pin becomes high level.

ENB input logic: The watchdog function turns on when the ENB pin becomes low level.

#### Ordering Information

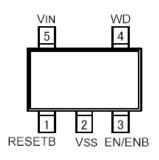
DESIGNATOR	ITEM	SYMBOL	DESCRIPTION
		A	3.13ms (TYP.)
		С	50ms (TYP.)
1	Release Delay Time(*1)	D	100ms (TYP.)
		E	200ms (TYP.)
		F	400ms (TYP.)
	Watchdog Timeout Period	2	50ms (TYP.)
		3	100ms (TYP.)
		4	200ms (TYP.)
2		5	400ms (TYP.)
		6	1.6s (TYP.)
		7	800ms (TYP.)
		16,22,23,24,29,	Detect voltage
34	Detect Voltage	30,31,44,45,46 <sup>(*2)</sup>	ex.) 4.5∨: ③⇒4, ④⇒5
56-7(*3)	Package	MR-Q	SOT-25 (3,000pcs/Reel)
	(Order Unit)		001-20 (0,000pc3/1/cel)

<sup>(\*1)</sup> Please set the release delay time shorter than or equal to the watchdog timeout period.

ex.) XD6123F523MR or XD6123F623MR

<sup>(\*2)</sup> For other output voltages, please contact your local Torex sales office or representative. The output voltage optional range is 1.6V to 5.0V. <sup>(\*3)</sup> The "-Q" suffix denotes "AEC-Q100" and "Halogen and Antimony free" as well as being fully EU RoHS compliant.

### ■ PIN CONFIGURATION



SOT-25 (TOP VIEW)

### ■ PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTIONS	
SOT-25		1 ono none	
1	RESETB	Reset Output	
2	Vss	Ground	
3	EN/ENB	Watchdog ON/OFF Control	
4	WD	Watchdog	
5	V <sub>IN</sub>	Power Input	

# ■ PIN LOGIC CONDITIONS

PIN NAME	LOGIC	CONDITIONS
Vin	Н	Vin≥Vdfl+Vhys
VIN	L	V <sub>IN≦</sub> V <sub>DFL</sub>
EN/ENB	Н	V <sub>EN</sub> /V <sub>ENB</sub> ≧1.30V
	L	V <sub>EN</sub> /V <sub>ENB</sub> ≦0.35V
	Н	The state maintaining WD≥VwDH for more than twD
W/D	L	The state maintaining WD <u>≤</u> VwDL for more than twD
WD	L→H	V <sub>WDL</sub> →V <sub>WDH</sub> , 300ns≦t <sub>WDIN</sub> ≦t <sub>WD</sub>
	H→L	V <sub>WDH</sub> →V <sub>WDL</sub> , 300ns≦t <sub>WDIN</sub> ≦t <sub>WD</sub>

NOTE:

VorL: Detect Voltage VHYS: Hysteresis Range VWDH: WD High Level Voltage VWDL: WD Low Level Voltage tWDIN: WD Pulse Width tWD: WD Timeout Period For the details of each parameter, please see the electrical characteristics.

# XD6121/XD6122/XD6123/XD6124 Series

### ■ FUNCTION CHART

Vin	XD6121/XD6122	XD6123/XD6124	Vwd	Vresetb (*2)								
VIN	V <sub>EN</sub>	V <sub>ENB</sub>	VWD	VRESETB V								
			Н									
		L	L	Repeating detect and release $(H \rightarrow L \rightarrow H)$								
Н	Н		L	L	L	L	L	L	L	L	OPEN	
			L⇔H	Н								
Н		Н	*1	Н								
L		L	I	L								

NOTE:

\*1: Including all logics of the WD (V<sub>WD</sub>=H, L, OPEN,  $H \rightarrow L$ ,  $L \rightarrow H$ ).

\*2: When the VRESETB is High, the circuit is in the release state.

When the VRESETB is Low, the circuit is in the detection state.

\*3:  $V_{IN}$ =L and  $V_{EN}/V_{ENB}$ =H cannot be combined because the rated input voltage of the EN/ENB pin is  $V_{ss}$ -0.3V to  $V_{IN}$ +0.3V.

\*4: The RESETB pin becomes indefinite operation while  $0.35V < V_{EN}/V_{ENB} < 1.3V$ .

\*5: The EN pin of the XD6121 series is not internally pulled up. When using the watchdog function, please drive the V<sub>EN</sub> pin in high level. The EN pin of the XD6122 series is internally pulled up. The watchdog function can be used even the EN pin left open. The ENB pin of the XD6123 series is not internally pulled down. When using the watchdog function, please drive the V<sub>ENB</sub> pin in low level. The ENB pin of the XD6124 series is internally pulled up.

### ■ABSOLUTE MAXIMUM RATINGS

				Ta=25°C
PARAMETE	ER	SYMBOL	RATINGS	UNITS
		Vin	-0.3~7.0	V
Input Volta	ge	V <sub>EN</sub> /V <sub>ENB</sub>	-0.3~V <sub>IN</sub> +0.3 or +7.0 <sup>(*1)</sup>	V
		Vwd	-0.3~+7.0	V
Output Current Output Voltage		Irbout	20	mA
		Vresetb	-0.3~+7.0	V
Dewer Dissignation	007.05	5 Pd	250	
Power Dissipation	SOT-25		600(40mm x 40mm Standard board) (*2)	mW
Operating Ambient Temperature Storage Temperature		Topr	-40 ~ +85	Oo
		Tstg	-55 ~ +125	°C

 $^{(^{\star}1)}$  The maximum value should be either  $V_{IN}$  +0.3 or +7.0 in the lowest.

<sup>(\*2)</sup> The power dissipation figure shown is PCB mounted and is for reference only. The mounting condition is please refer to PACKAGING INFORMATION.

# ■ ELECTRICAL CHARACTERISTICS

Ta=25 °C

PARAMETER	SYMBOL		COND	ITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUIT
		V <sub>EN</sub> =V <sub>SS</sub>			V <sub>DFL(T)</sub>	VDFL(T)	VDFL(T)×		
Detect Voltage	Vdfl			-40°C ≤ Topr <u>&lt;</u> 85 °C	× 0.98 V <sub>DFL(T)</sub> × 0.96	VDFL(T)	1.02 VDFL(T)× 1.04	V	1
		V <sub>EN</sub> =V <sub>SS</sub>			V <sub>DFL</sub> × 0.02	V <sub>DFL</sub> × 0.05	V <sub>DFL</sub> × 0.08		
Hysteresis Width	VHYS			$-40^{\circ}C \le Topr \le 85^{\circ}C$	Vdfl	Vdfl	Vdfl	V	1
		WD=OPEN, V	/in=Vdfl		× 0.01 -	× 0.05 5	× 0.08 11		
				-40 <sup>0</sup> C <u>≤</u> Topr <u>≤</u> 85 <sup>0</sup> C	-	-	20		
Supply Current (*1)	lss	WD=OPEN, V	/in=Vdfl	L_(T) <b>×1.1</b> V	-	10	16	<i></i>	1
Supply Current (*1)	155			-40°C <u>&lt;</u> Topr <u>&lt;</u> 85 °C	-	-	28	μA	U
		WD=OPEN, V	/ <sub>IN</sub> =6.0\	/	-	12	18		
				-40°C <u>≤</u> Topr <u>&lt;</u> 85 °C	-	-	35		
Operating Voltage	Vin			-40 <sup>0</sup> C <u>≤</u> Topr <u>≤</u> 85 <sup>0</sup> C	1.0	-	6.0	V	1
				VIN=1.0V	0.15	0.5	-		
Output Current		N-ch.	V <sub>IN</sub> =	2.0V (V <sub>DFL(T)</sub> > 2.0V)	2.0	2.5	-	A	3
Output Current	Irbout	VDS=0.5V	V <sub>IN</sub> =	3.0V (V <sub>DFL(T)</sub> >3.0V)	3.0	3.5	-	mA	
			V <sub>IN=</sub>	4.0V (V <sub>DFL(T)</sub> >4.0V)	3.5	4.0	-		
		Time until VIN is increased from 1.0V to 2.0V and attains to the release time level, and the Reset output pin releases.		2.00	3.13	5.00		4	
	tor			37	50	63	ms		
Release Delay Time (V <sub>DFL</sub> ≤1.8V)				75	100	125			
				150	200	250			
					300	400	500		
					2.00	3.13	5.00		
	tor	Time until $V_{IN}$ is increased from 1.0V to ( $V_{DFL} x 1.1V$ ) and attains to the release time level, and the Reset output pin releases.		37	50	63	ms	4	
Release Delay Time (V <sub>DFL</sub> ≥1.9V)				75	100	125			
				150	200	250			
				300	400	500			
Detect Delay Time	tdF	Time until $V_{IN}$ is decreased from 6.0V to 1.0V and attains to the detect voltage level, and the Reset output pin detects while the WD pin left open.		-	5.5	33	β	4	
V <sub>DFL</sub> Leakage Current	ILEAK	VIN=6.0V, VR	esetb <b>=6</b>	.0V	-	0.01	0.1	μA	3
					37	50	63		
		Time until V <sub>II</sub>	increa	ses form	75 100	125			
Watchdog	t	1.0V to 2.0V			150	200	250	<b>m</b> 0	5
Timeout Period (V <sub>DFL</sub> ≤1.8V)	two			is released to go	300	400	500	ms	
		into the deter	ction sta	ate. (WD=OPEN)	600	800	1000		
				1200	1600	2000	ſ		
					37	50	63		
Watchdog Timeout Period (V <sub>DFL≥</sub> 1.9V)		Time until V <sub>II</sub>	increa	ises from	75	100	125		
		1.0V to (V <sub>DFL</sub>			150	200	250		
		and the Reset output pin is released to go into the detection state. (WD=OPEN)		300	400	500	ms	5	
				600	800	1000			
				1200	1600	2000			

# ELECTRICAL CHARACTERISTICS (Continued)

Ta=25 °C SYMBOL CONDITIONS MIN. TYP. UNITS CIRCUIT PARAMETER MAX. VIN=6.0V, Watchdog Apply pulse from 6.0V to 0V to the WD 300 6 . ns twdin \_ Minimum Pulse Width pin. Watchdog Vwdh VIN=VDFL x 1.1V ~ 6.0V -40°C < Topr < 85 °C Vin x 0.7 -6 V 6 High Level Voltage Watchdog VWDL VIN=VDFL x 1.1V ~ 6.0V -40°C < Topr < 85 °C 0 -VIN x 0.3 V 6 Low Level Voltage Watchdog  $R_{WD}$ 300 600 900 kΩ  $\bigcirc$ Vwd=6V, Rwd=Vwd/Iwd Pull-down Resistance EN/ENB VENH/VENBH VIN=VDFL x 1.1V ~ 6.0V -40°C < Topr < 85 °C 1.3 V (8) -VIN High Level Voltage EN/ENB VENL/VENBL VIN=VDFL x 1.1V ~ 6.0V -40°C -40°C -40°C 0 0.35 V 8 -Low Level Voltage EN Pull-up REN VIN=6.0V, VEN=0V, REN=VIN / IEN Resistance (\*2) 9 1.0 1.6 2.4 MΩ ENB Pull-down VIN=6.0V, VENB=6V, RENB=VENB / IENB Renb

NOTE:

\* In case where no EN/ENB pin's condition written in the test condition field,  $V_{EN}=V_{IN}$  and  $V_{ENB}=V_{SS}$ .

\*\*  $V_{DFL(T)}$  =Setting detect voltage value

\*\*\* The values for -40°C $\leq$ Ta $\leq$ 85°C are designed values.

 $^{(*1)}$  The condition when the watchdog pin is ON.

The EN/ENB pin is CMOS input. For the XD6122 (pull-up resistor) and XD6124 (pull-down resistor),

supply current increases in the following values when the watchdog function is OFF.

XD6122 Series : (V\_{IN}-V\_{EHL}) /1.6M\Omega (TYP.)

XD6124 Series : V<sub>EHBH</sub>/1.6MΩ (TYP.)

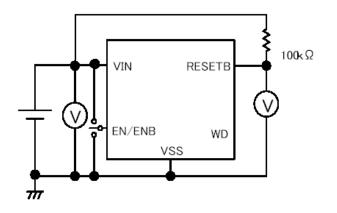
(\*2) For the XD6122 series only.

Resistance (\*3)

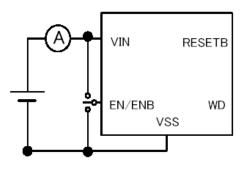
 $^{(^{\ast}3)}$  For the XD6124 series only.

# ■TEST CIRCUITS

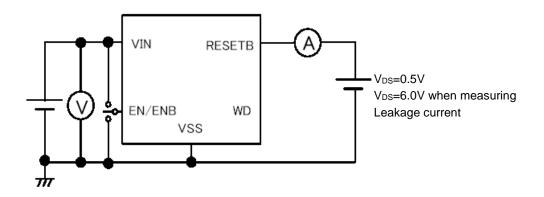
 $\text{Circuit} \ \textcircled{1}$ 



Circuit (2)

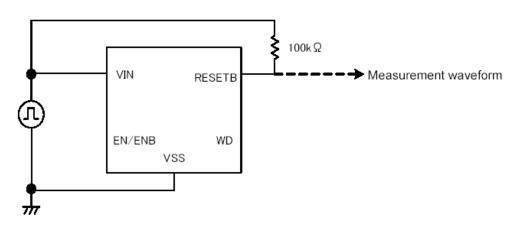


Circuit ③

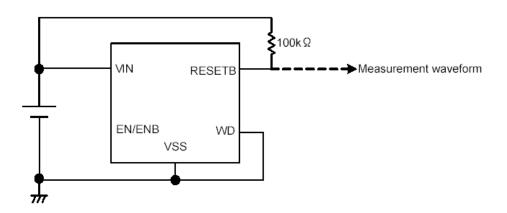


# ■TEST CIRCUITS (Continued)

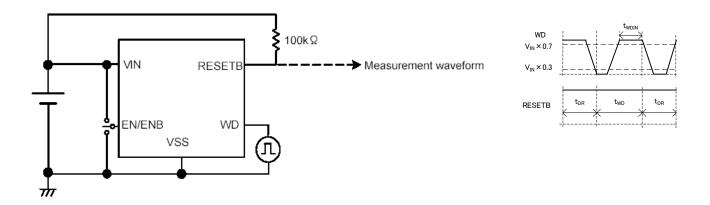
Circuit ④



Circuit (5)

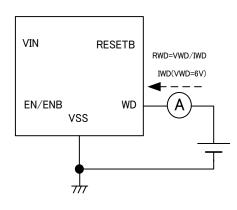


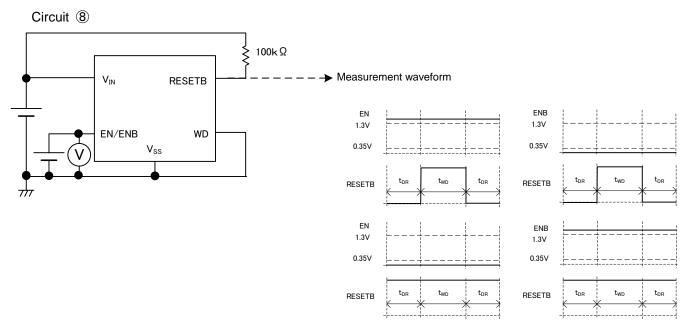
Circuit (6)



# ■TEST CIRCUITS (Continued)

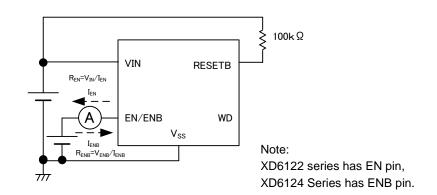
 $\text{Circuit} \ \bigcirc \\$ 





Note: The above reference is about the EN/ENB logic operation.

Circuit (9)



### ■OPERATIONAL EXPLANATION

The XD6121/6122/6123/6124 series compare, using the error amplifier, the voltage of the internal voltage reference source with the voltage divided by R1, R2 and R3 connected to the  $V_{IN}$  pin. The resulting output signal from the error amplifier activates the watchdog logic, delay circuit and the output driver. When the VIN pin voltage gradually falls and finally reaches the detect voltage, the RESETB pin output goes from high to low in the case of the V<sub>DFL</sub> type ICs.

#### <RESETB / RESET Pin Output Signal>

\*  $V_{\text{DFL}}$  (RESETB) type - output signal: Low when detected.

The RESETB pin output goes from high to low whenever the  $V_{IN}$  pin voltage falls below the detect voltage. The RESETB pin remains low for the release delay time ( $t_{DR}$ ) after the  $V_{IN}$  pin voltage reaches the release voltage. If neither rising nor falling signals are applied to the WD pin within the watchdog timeout period, the RESETB pin output remains low for the release delay time ( $t_{DR}$ ), and thereafter the RESET pin outputs high level signal.

#### <Hysteresis>

When the internal comparator output is high, the NMOS transistor connected in parallel to R3 is turned ON, activating the hysteresis circuit. The difference between the release and detect voltages represents the hysteresis width, as shown by the following calculations:

V<sub>DFL</sub> (detect voltage) = (R1+R2+R3) x Vref / (R2+R3) V<sub>DR</sub> (release voltage) = (R1+R2) x Vref / (R2) V<sub>HYS</sub> (hysteresis width) =V<sub>DR</sub>-V<sub>DFL</sub> (V) V<sub>DR</sub> > V<sub>DFL</sub>

\* Please refer to the block diagrams for R1, R2, R3 and Vref.

\* Hysteresis width is selectable from VDFL x 0.05V (TYP.).

#### <Watchdog (WD) Pin>

The series use a watchdog timer to detect malfunction or "runaway" of the microprocessor. If neither rising nor falling signals are applied from the microprocessor within the watchdog timeout period, the RESETB pin output maintains the detection state for the release delay time ( $t_{DR}$ ), and thereafter the RESETB pin outputs low to high signal. The watchdog pin is pulled down to the V<sub>SS</sub> internally. When the watchdog pin is not connected, A reset signal comes out after the watchdog timeout period. Six watchdog timeout period settings ( $t_{WD}$ ) are available in 1.6s, 800ms, 400ms, 200ms, 100ms, and 50ms.

#### <EN Pin>

In case where the watchdog function is not used, When the EN pin input driven to low level, only the watchdog function is forced off while the detect voltage circuit remains operation. For using the watchdog function, the EN pin should be used in high level. Even after the input voltage and the EN pin voltage are driven back high, the RESETB pin output maintains the detection state for the release delay time ( $T_{DR}$ ). (Refer to the TIMING CHART 1-①.) The watchdog function recovers immediately when the input voltage becomes higher than the release voltage and the EN pin voltage driven from low to high level. (Refer to the TIMING CHART 1-②.) A diode, which is an input protection element, is connected between the EN pin and  $V_{IN}$  pin. Therefore, if the EN pin is applied voltage that exceeds  $V_{IN}$ , the current will flow to  $V_{IN}$  through the diode. For avoiding any damage to the IC, please use this IC within the stated maximum ratings ( $V_{SS}$ -0.3 ~  $V_{IN}$ +0.3) on the EN pin.

#### <ENB Pin>

In case where the watchdog function is not used, when the ENB pin input driven to high level, only the watchdog function is forced off while the detect voltage circuit remains operation. For using the watchdog function, the ENB pin should be used in low level. Even after the input voltage and the ENB pin voltage are driven back low, the RESETB pin output maintains the detection state for the release delay time ( $t_{DR}$ ). (Refer to the TIMING CHART 2-①.) The watchdog function recovers immediately when the input voltage becomes higher than the release voltage and the ENB pin voltage driven from high to low level. (Refer to the TIMING CHART 2-②.) A diode, which is an input protection element, is connected between the ENB pin and V<sub>IN</sub> pin. Therefore, if the ENB pin is applied voltage that exceeds V<sub>IN</sub>, the current will flow to V<sub>IN</sub> through the diode. For avoiding any damage to the IC, please use this IC within the stated maximum ratings (Vss -0.3 ~ V<sub>IN</sub> +0.3) on the ENB pin.

#### <Release Delay Time>

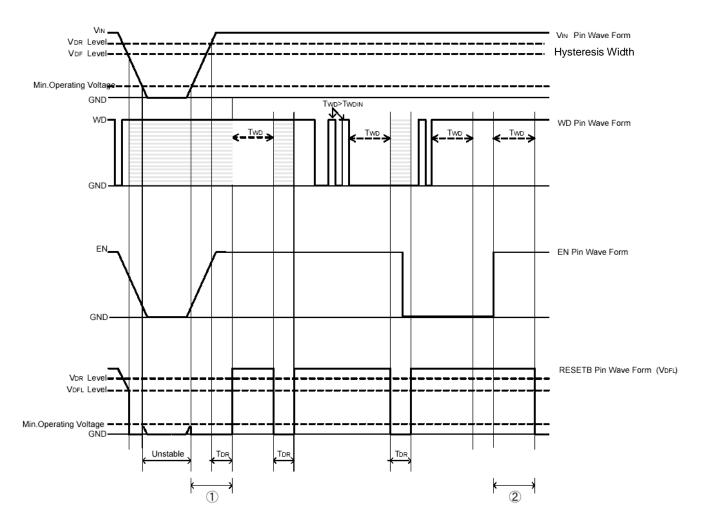
Release delay time ( $t_{DR}$ ) is the time that elapses from when the V<sub>IN</sub> pin reaches the release voltage, or when the watchdog timeout period expires with no rising signal applied to the WD pin, until the RESETB pin output is released from the detection state. Five release delay time ( $t_{DR}$ ) watchdog timeout period settings are available in 400ms, 200ms, 100ms, 50ms, and 3.13ms.

#### <Detect Delay Time>

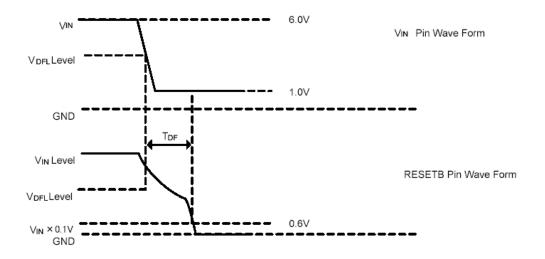
Detect Delay Time (t<sub>DF</sub>) is the time that elapses from when the V<sub>IN</sub> pin voltage falls to the detect voltage until the RESETB pin output goes into the detection state.

### ■TIMING CHARTS

- 1. XD6121/XD6122 Series (EN products)
- N-ch Open Drain Output (Rpull=100k  $\Omega$ )



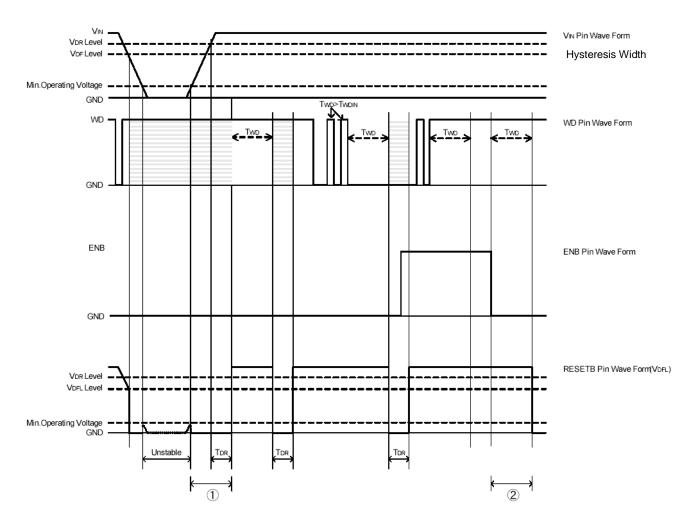
•  $t_{DF}$  (N-ch Open Drain Output, Rpull=100k $\Omega$ )



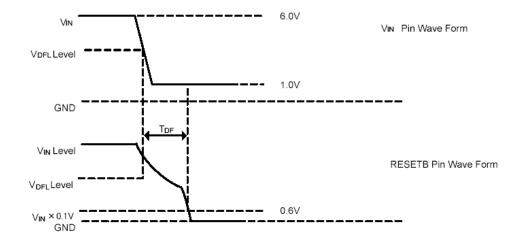
TOIREX

# ■TIMING CHARTS (Continued)

- 2. XD6123/XD6124 Series (ENB products)
- N-ch Open Drain Output (Rpull=100k  $\Omega$ )

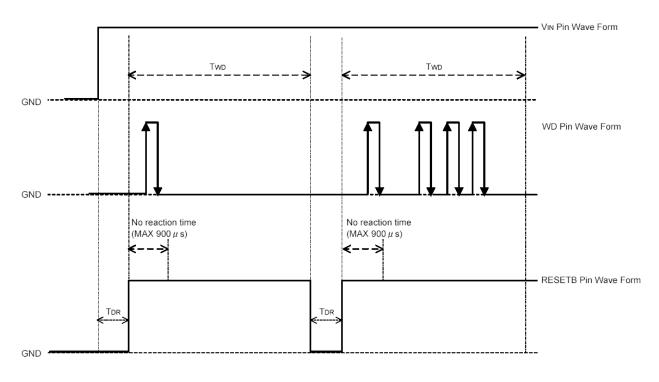


•tor (N-ch Open Drain Output, Rpull=100k $\Omega$ )



### ■NOTES ON USE

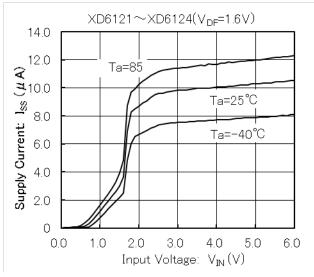
- 1. Please use this IC within the stated maximum ratings. For temporary, transitional voltage drop or voltage rising phenomenon, the IC is liable to malfunction should the ratings be exceeded.
- 2. When a resistor is connected between the V<sub>IN</sub> pin and the input, the V<sub>IN</sub> voltage drops while the IC is operating and a malfunction may occur as a result of the IC's through current.
- 3. In order to stabilize the IC's operations, please ensure that the V<sub>IN</sub> pin's input frequency's rise and fall times are more than 1 μ s/V.
- 4. Noise at the power supply may cause a malfunction of the watchdog operation or the voltage detector. In such case, please strength  $V_{IN}$  and GND lines. Also, please connect a capacitor such as  $0.22 \,\mu$  F between the  $V_{IN}$  pin and the GND pin and evaluate the device on the actual board carefully before use.
- 5. Protecting against a malfunction while the watchdog time out period, an ignoring time (no reaction time) occurs to the rise and fall times. Referring to the figure below, the ignoring time (no reaction time) lasts for  $900 \,\mu$  s at maximum. (refer to the Figure 1 below)
- 6. The EN pin of the XD6121 series is not internally pulled up. When using the watchdog function, please drive the V<sub>EN</sub> pin in high level. The EN pin of the XD6122 series is internally pulled up. The watchdog function can be used even the EN pin left open. The ENB pin of the XD6123 series is not internally pulled down. When using the watchdog function, please drive the V<sub>ENB</sub> pin in low level. The ENB pin of the XD6124 series is internally pulled down. The watchdog function can be used even the ENB pin left open.
- 7. Torex places an importance on improving our products and its reliability. However, by any possibility, we would request user fail-safe design and post-aging treatment on system or equipment.



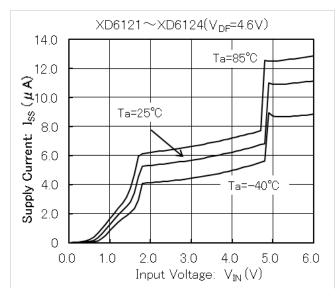
[Figure1]

# TYPICAL PERFORMANCE CHARACTERISTICS

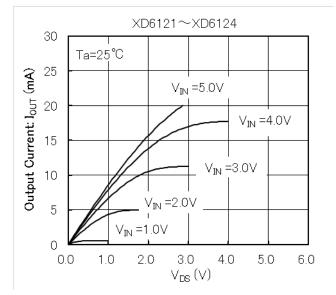
#### (1.) Supply Current vs. Input Voltage

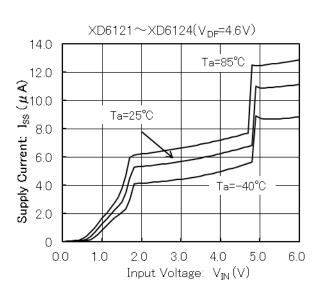


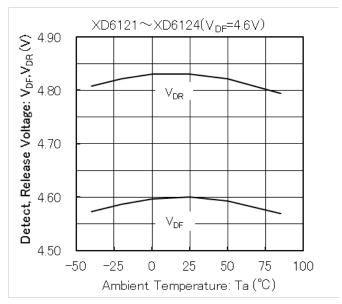
(2.) Ambient Temperature vs. Detect Release Voltage

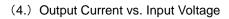


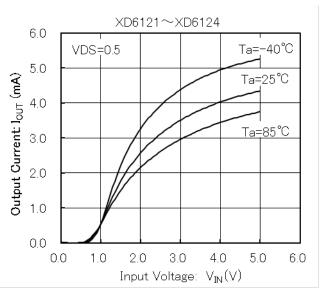
(3.) Output Current vs. VDS



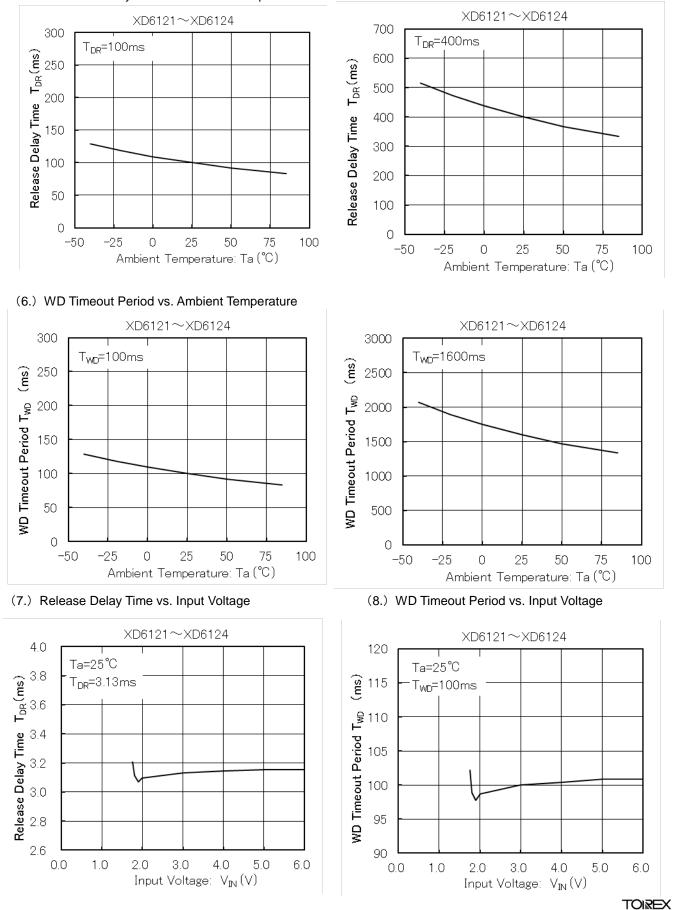








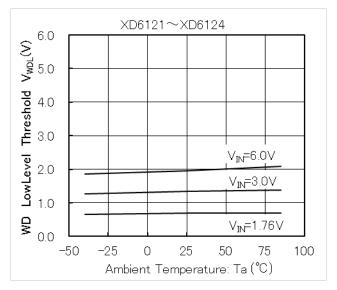
# ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

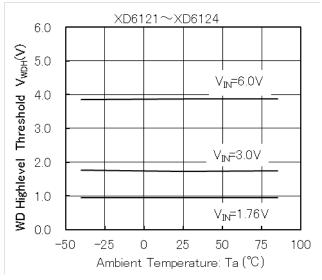


#### (5.) Release Delay Time vs. Ambient Temperature

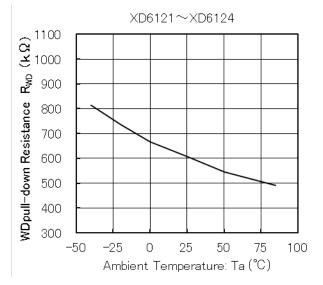
# ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

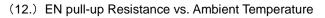
- (9.) WD Low Level Voltage vs. Ambient Temperature
- (10.) WD High Level Voltage vs. Ambient Temperature

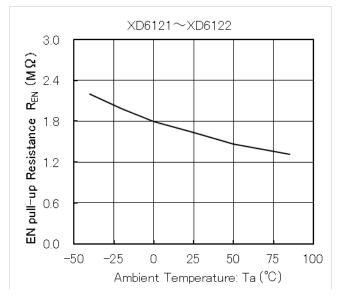




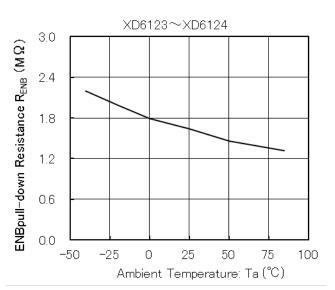
#### (11.) WD pull-down Resistance vs. Ambient Temperature



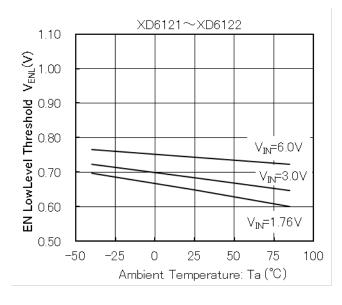




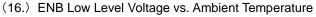
#### (13.) ENB pull-up Resistance vs. Ambient Temperature

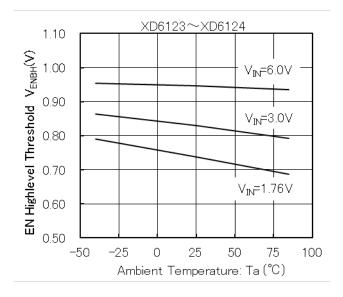


### ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



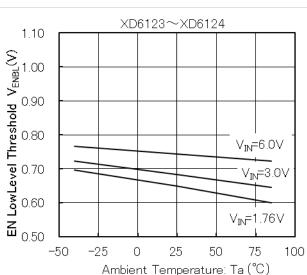
#### (14.) EN Low Level Voltage vs. Ambient Temperature





XD6121~XD6122 1.10 EN Highlevel Threshold V<sub>ENH</sub>(V) 1.00 V<sub>IN</sub>=6.0V 0.90 V<sub>IN</sub>=3.0V 0.80 0.70 V<sub>IN</sub>=1.76V 0.60 0.50 -50 -25 0 25 50 75 100 Ambient Temperature: Ta (°C)

(15.) EN High Level Voltage vs. Ambient Temperature



(17.) ENB High Level Voltage vs. Ambient Temperature

# XD6121/XD6122/XD6123/XD6124 Series

# ■ PACKAGING INFORMATION

For the latest package information go to, www.torexsemi.com/technical-support/packages

PACKAGE	OUTLIN / LAND PATTERN	THERMAL CHARACTERISTICS	
SOT-25	SOT-25 PKG	Standard Board	SOT-25 Power Dissipation

# ■MARKING RULE

1 represents products series

MARK	PRODUCT SERIES
В	XD6121/XD6122/XD6123/XD6124*****-Q

(2) represents internal sequential number.

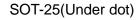
01、…、09、10、…、99、A0、…、A9、B0、…、B9、…、Z9… repeated. (G, I, J, O, Q, W excluded)

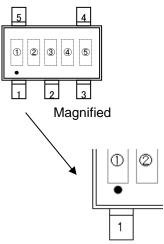
MARK	PRODUCT SERIES
01	XD6121A246MR-Q
02	XD6122C629MR-Q
03	XD6123C330MR-Q
04	XD6124E616MR-Q
05	XD6121C622MR-Q
06	XD6122C645MR-Q

(4) (5) represents production lot number

01~09, 0A~0Z, 11~9Z, A1~A9, AA~AZ, B1~ZZ in order.(G, I, J, O, Q, W excluded)

\* No character inversion used.





- 1. The product and product specifications contained herein are subject to change without notice to improve performance characteristics. Consult us, or our representatives before use, to confirm that the information in this datasheet is up to date.
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Do not use the product for in-vehicle use or other uses unless agreed by us in writing in advance.

- 5. Although we make continuous efforts to improve the quality and reliability of our products; nevertheless Semiconductors are likely to fail with a certain probability. So in order to prevent personal injury and/or property damage resulting from such failure, customers are required to incorporate adequate safety measures in their designs, such as system fail safes, redundancy and fire prevention features.
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